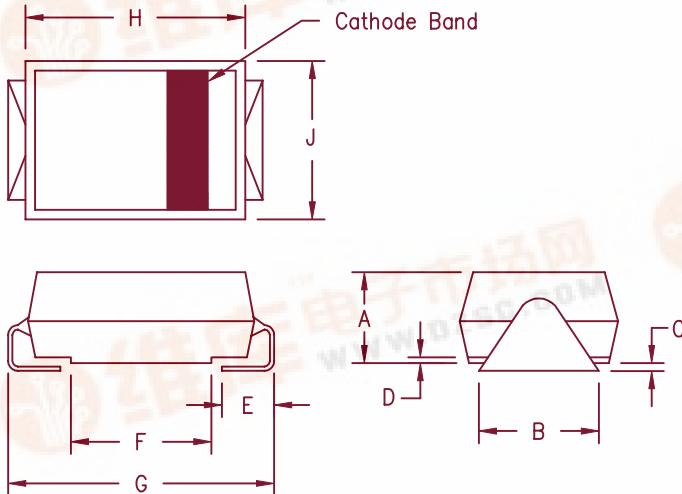


1 Amp Standard Recovery Rectifier GS1A - GS1M



Dim.	Inches		Millimeter		Notes
	Minimum	Maximum	Minimum	Maximum	
A	.078	.115	1.98	2.95	
B	.067	.089	1.70	2.25	
C	.002	.008	0.05	0.20	
D	---	0.02	---	0.51	
E	.035	.055	0.89	1.40	
F	.065	.096	1.65	2.45	
G	.205	.224	5.21	5.69	
H	.160	.180	4.06	4.57	
J	.100	.112	2.57	2.84	

DO-214AC
(SMAJ) (High Profile)

Microsemi Catalog Number	Working Reverse Voltage	Peak Reverse Voltage
GS1A	50V	50V
GS1B	100V	100V
GS1D	200V	200V
GS1G	400V	400V
GS1J	600V	600V
GS1K	800V	800V
GS1M	1000V	1000V

- High soldering temp. -250°C , 10sec.
- 150°C Junction Temperature
- Low thermal resistance

Electrical Characteristics

Average forward current
Maximum surge current
Max peak forward voltage
Max peak reverse current
Max peak reverse current
Typical junction capacitance

$I_{F(AV)}$ 1 Amp
 I_{FSM} 30 Amps
 V_{FM} 1.1 Volts
 I_{RM} 10 μA
 I_{RM} 50 μA
 C_J 25 pF

$T_L = 75^{\circ}\text{C}$, $V_R = V_{RRM}$
8.3ms, half sine
 $I_{FM} = 1\text{A}$: $T_J = 25^{\circ}\text{C}^*$
 $V_{RRM}, T_J = 25^{\circ}\text{C}$
 $V_{RRM}, T_J = 125^{\circ}\text{C}^*$
 $V_R = 5.0\text{V}, T_J = 25^{\circ}\text{C}$

*Pulse test: Pulse width 300 usec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temperature range
Operating temperature range
Max thermal resistance – Junction to Lead

T_{STG}
 T_J
 $R_{\theta JL}$

-55°C to 150°C
 -55°C to 150°C
 $15^{\circ}\text{C}/\text{W}$

GS1A — GS1M

Figure 1
Typical Forward Characteristics

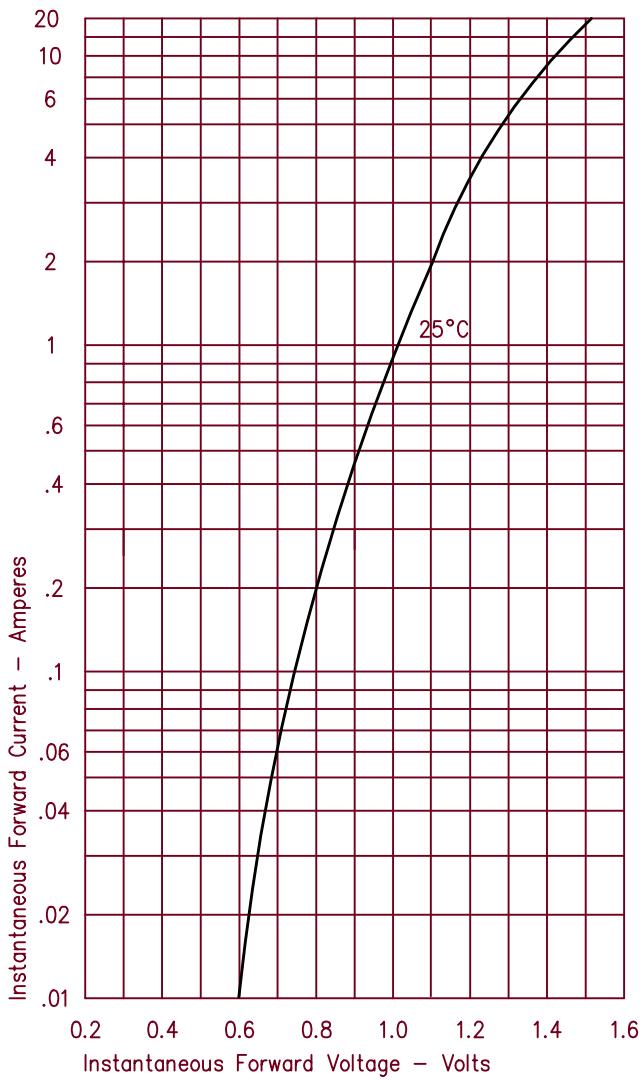


Figure 2
Typical Junction Capacitance

